

L Number	Hits	Search Text	DB	Time stamp
1	1532	257/719	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/05 13:15
2	1172	257/720	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/05 13:36
3	481	257/721	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/05 13:56
4	1720	257/722	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/05 14:01
5	2781	257/690	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/05 14:17
6	4215	257/778	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/05 14:31
7	1747	257/779	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/05 14:49
8	2067	257/780	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/05 15:06
9	1118	257/782	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/05 15:24
10	1719	257/783	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/05 15:45
11	2691	257/784	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/05 16:06
12	2680	257/786	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/05 16:25
13	821	257/E23.101	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/05 16:43
14	505	257/E23.102	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/05 16:52

15	661	257/E23.103	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/05 16:56
16	326	257/E23.104	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/05 17:08
17	612	257/E23.105	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/05 17:11
18	529	257/E23.106	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/05 17:17
19	395	257/E23.107	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/05 17:21
20	40	257/E23.108	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/05 17:25
21	215	257/E23.109	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/05 17:25
22	0	257/E23.110	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/05 17:26
23	247	257/E23.111	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/05 17:27
24	376	257/E23.112	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/05 17:30
25	153	257/E23.113	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/05 17:33
26	0	257/E21.523	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/05 17:33
-	280	438/68	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 16:09
-	1369	438/113	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 17:54

-	451	438/114	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 18:01
-	957	438/458	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 18:25
-	1053	438/460	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 18:26
-	320	438/461	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 18:36
-	1350	(semiconductor or chip or die or IC) and (heatsink or heat near (sink or spreader or dissipat\$3 or transfer)) with metal\$5 and (dielectric or insulat\$3) and (ball or bump)	USPAT	2004/11/04 18:32
-	955	438/462	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 18:39
-	186	438/463	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 18:47
-	1		USPAT	2004/11/04 18:42
-	1		USPAT	2004/11/04 18:42
-	1		USPAT	2004/11/04 18:42
-	1409	438/464	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 18:49
-	715	438/465	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 19:01
-	1	438/FOR386	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 19:01
-	0	438/FOR387	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 19:01
-	867	257/620	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 19:05
-	1387	257/675	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 19:13

-	2509	257/706	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 19:26
-	1952	257/707	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 19:39
-	3506	257/712	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 19:56
-	2169	257/713	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 20:13
-	1764	257/714	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 20:26
-	814	257/715	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 20:37
-	4	20010010407.pn. or 20020043727.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 20:33
-	361	257/716	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 20:44
-	1534	257/717	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/04 20:47
-	1941	257/718	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/11/05 12:53